

# 6A, 200V - 600V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Very low profile, typical height of 1.1mm
- · Excellent high temperature stability
- Glass passivated chip junction
- Controlled avalanche characteristics
- Low leakage current
- High forward surge capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

#### **MECHANICAL DATA**

- Case: TO-277A (SMPC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.095g (approximately)

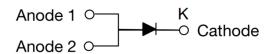
KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	6	Α	
$V_{RRM}$	200 - 600	V	
I <sub>FSM</sub>	80	Α	
$T_{JMAX}$	175	°C	
Package	TO-277A (SMPC)		
Configuration	Single die		







**TO-277A (SMPC)** 



PARAMETER	SYMBOL	TPUH6DH	TPUH6JH	UNIT
Marking code on the device		UH6D	UH6J	
Repetitive peak reverse voltage	$V_{RRM}$	200	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	420	V
Forward current	I <sub>F</sub>	6		Α
Surge peak forward current 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	80		А
Junction temperature	$T_J$	-55 to +175		°C
Storage temperature	T <sub>STG</sub>	-55 to +175		°C



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance <sup>(1)</sup>	R <sub>OJL</sub>	12	°C/W
Junction-to-ambient thermal resistance <sup>(2)</sup>	R <sub>OJA</sub>	80	°C/W

#### Notes:

- 1. Mounted on FR4 PCB with 16mm x 16mm Cu pad area
- 2. Free air, mounted on recommended pad

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	TPUH6DH	I <sub>F</sub> = 3A, T <sub>J</sub> = 25°C	V <sub>F</sub>	0.80	-	V
	TPUH6JH			1.98	-	V
	TPUH6DH	I <sub>F</sub> = 6A, T <sub>J</sub> = 25°C		0.87	1.05	V
	TPUH6JH			2.45	3.00	V
	TPUH6DH	I <sub>F</sub> = 3A, T <sub>J</sub> = 125°C		0.65	-	V
	TPUH6JH			1.23	-	V
	TPUH6DH	I <sub>F</sub> = 6A, T <sub>J</sub> = 125°C		0.73	0.90	V
	TPUH6JH			1.59	1.80	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>		T <sub>J</sub> = 25°C	- I <sub>R</sub>	-	10	μA
		T <sub>J</sub> = 125°C		-	200	μA
Junction capacitance		1MHz, $V_R = 4.0V$	CJ	50	-	pF
Reverse recovery time		IF = 0.5A, IR = 1.0A Irr = 0.25A	t <sub>rr</sub>	ı	25	ns
		$I_F = 1A$ , di/dt = -50A/ $\mu$ s $V_R = 30V$	t <sub>rr</sub>	-	45	ns

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup> PACKAGE PACKING				
TPUH6xH	TO-277A (SMPC)	6,000 / Tape & Reel		

#### Notes:

1. "x" defines voltage from 200V(TPUH6DH) to 600V(TPUH6JH)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

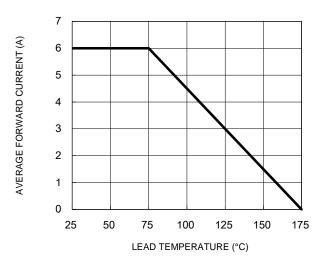


Fig.3 Typical Reverse Characteristics

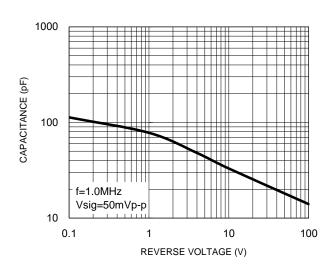
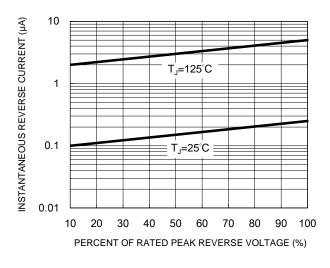


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



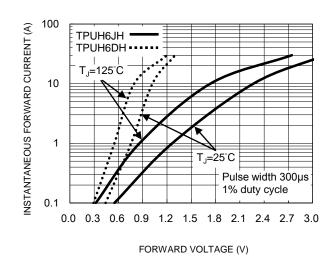
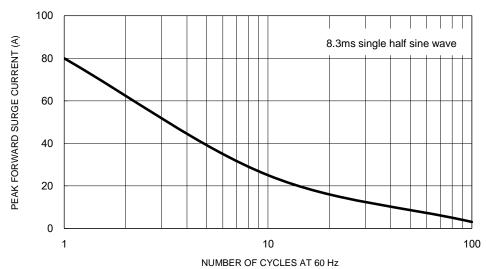


Fig.5 Maximum Non-Repetitive Forward Surge Current



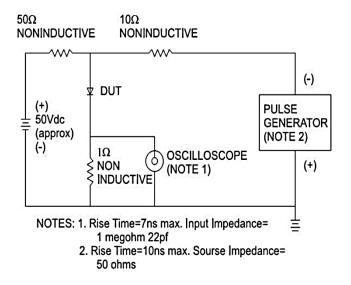
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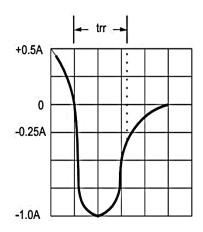


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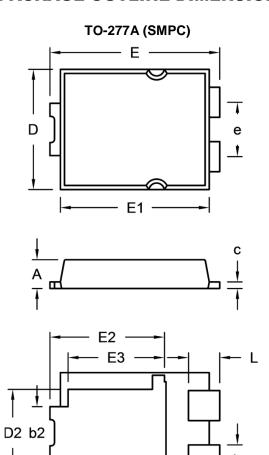
Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram





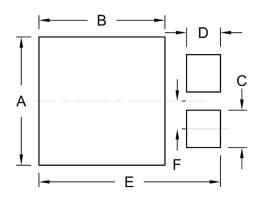


## **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit	(mm)	Unit (	(inch)
DIIVI.	Min.	Max.	Min.	Max.
Α	1.000	1.200	0.039	0.047
b	1.000	1.300	0.039	0.051
b2	1.850	2.150	0.073	0.085
С	0.175	0.325	0.007	0.013
D	4.550	4.650	0.179	0.183
D2	3.170	3.470	0.125	0.137
E	6.350	6.650	0.250	0.262
E1	5.650	5.750	0.222	0.226
E2	4.235	4.535	0.167	0.179
E3	3.540	3.840	0.139	0.151
е	1.930	2.230	0.076	0.088
L	1.043	1.343	0.041	0.053

## **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	4.80	0.189
В	4.72	0.186
С	1.40	0.055
D	1.27	0.050
E	6.80	0.268
F	1.04	0.041

## **MARKING DIAGRAM**



P/N = Marking Code YW = Date Code F = Factory Code



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